ASMT-TxBM-Nxxxx

Surface Mount LED Indicator



Data Sheet





Description

Avago Technologies' ASMT-TxBM-Nxxxx Mini PLCC-2 SMT LEDs are designed specifically for use in Interior Automotive applications. They have a wide viewing angle of 120° making them ideally suited for instrument cluster panel, push button, HVAC and ambient decorative lighting applications in automotive interiors.

The LEDs are packed in EIA-compliant tape and reel to facilitate easy pick and place assembly. Every reel will be shipped in single intensity and color bin, to provide close uniformity.

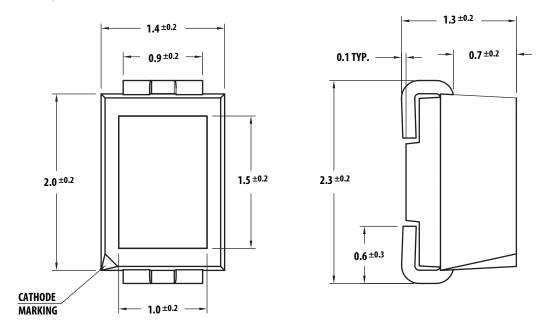
Features

- Industry standard Mini PLCC-2
- High reliability LED package
- High brightness using InGaN dice technologies
- High optical efficiency
- Wide vertical viewing angle at 120°
- Available is 8mm carrier tape on 7-inch reel
- Stable & consistent performance with minimum degradation
- JEDEC MSL 2

Applications

- Interior automotive
 - Instrument panel backlighting
 - Central console backlighting
 - Navigation and audio system backlighting
 - Push button backlighting
 - Ambient illumination
 - Car puddle lighting

Package Dimensions



Notes:

- 1. All dimensions in millimeters.
- 2. Terminal Finish: Ag plating.
- 3. Encapsulation material: Silicone resin.

Figure 1. Package Drawing

Table 1. Device Selection Guide

		Min. Iv	Typ. Iv	Max. Iv	Test Curre	nt
Color	Part Number	(mcd)	(mcd)	(mcd)	(mA)	Dice Technology
Blue	ASMT-TBBM-NP902	56.0	100.0	180.0	20	InGaN
Green	ASMT-TGBM-NT502	285.0	480.0	900.0	20	InGaN

Notes:

- 1. The luminous intensity I_V , is measured at the mechanical axis of the lamp package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
- 2. Tolerance = $\pm 12\%$

Part Numbering System

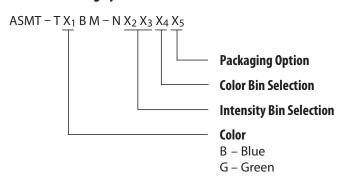


Table 2. Absolute Maximum Ratings ($T_A = 25$ °C)

Parameters	ASMT-TBBM-Nxxxx	ASMT-TGBM-Nxxxx		
DC Forward Current [1]		20 mA		
Peak Forward Current [2]		100 mA		
Power Dissipation		72 mW		
Reverse Voltage, V _R @ 10 μA	Not Recommended for Reverse Bias			
Junction Temperature	110°C	110°C 125°C		
Operating Temperature	-40°	-40°C to +100°C		
Storage Temperature	-40°	-40°C to +100°C		

Notes:

- Derate Linearly as shown in Figure 6.
 Duty Factor = 10%, Frequency = 1kHz

Table 3. Optical Characteristics ($T_J = 25$ °C)

		Dice	Peak Wavelength λ _{PEAK} (nm)	$\begin{array}{l} \text{Dominant} \\ \text{Wavelength}^{[1]} \\ \lambda_{\text{D}} \text{ (nm)} \end{array}$	Vertical Viewing Angle $2\theta_{1/2}^{-1}$ (Degrees)	$\begin{array}{l} \text{Total Flux} / \\ \text{Luminous Intensity} \\ \Phi_{\text{V}} (\text{Im}) / \text{I}_{\text{V}} (\text{cd}) \end{array}$
Color	Part Number	Technology	Тур.	Тур.	Тур.	Тур.
Blue	ASMT-TBBM-Nxx02	InGaN	459.5	465.0	120	2.8
Green	ASMT-TGBM-Nxx02	InGaN	516.0	522.0	120	2.8

Notes:

- 1. The dominant wavelength, λ_D , is derived from the CIE Chromaticity diagram and represents the color of the device.
- 2. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.

Table 4. Electrical Characteristics ($T_J = 25$ °C)

Forward Voltage V _F (Volts) @ I _F = 20 mA		Thermal Resistance		
Part Number	Min.	Typ.	Max.	$R\theta_{JP}$ (°C/W)
ASMT-TBBM-Nxxx2	2.8	3.2	3.6	230
ASMT-TGBM-Nxxx2	2.9	3.3	4.0	230

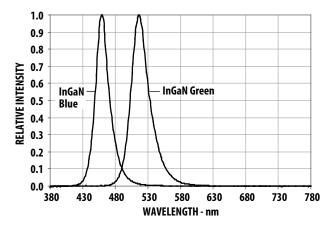


Figure 2. Relative Intensity Vs. Wavelength

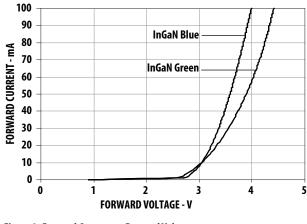


Figure 3. Forward Current vs. Forward Voltage.

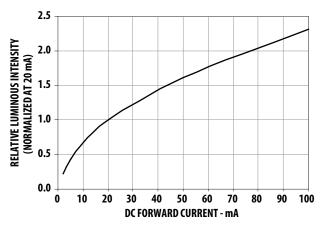


Figure 4. Relative Luminous Intensity vs. Forward Current

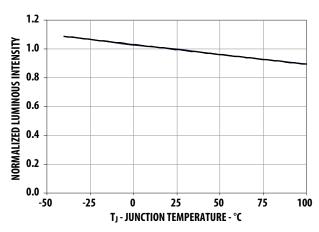


Figure 5. Relative Intensity vs. Temperature

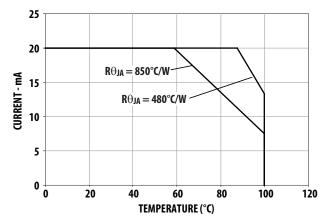


Figure 6. Maximum Forward Current Vs. Ambient Temperature. Derate Based on $T_{JMAX}\!=\!110^{\circ}\text{C}$, $R\theta_{JA}\!=\!850^{\circ}\text{C/W}$, 480°C/W .

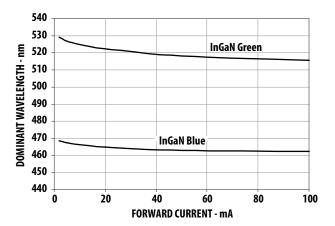


Figure 7. Dominant Wavelength Shift vs. Forward Current

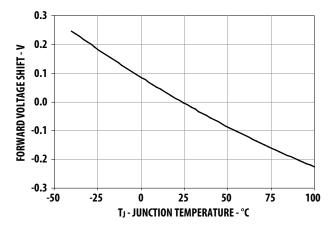


Figure 8. Forward Voltage Shift vs. Temperature.

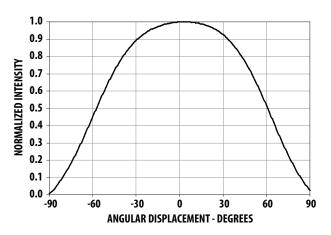


Figure 9. Radiation Pattern

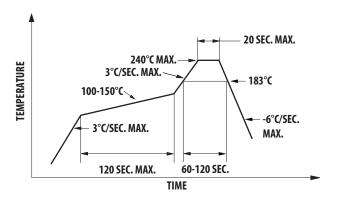


Figure 10a. Recommended SnPb Reflow Soldering Profile.

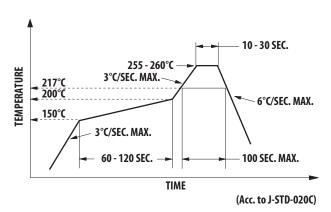


Figure 10b. Recommended Pb-Free Reflow Soldering Profile.

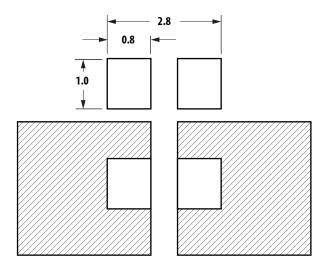
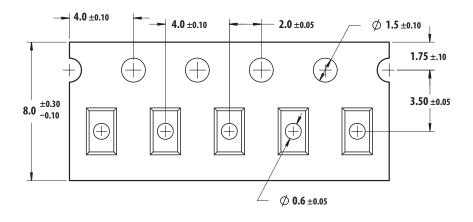


Figure 11. Recommended Soldering Pad Pattern.



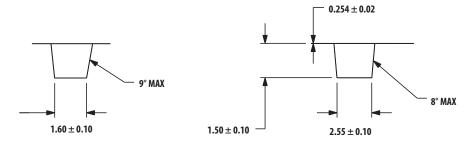


Figure 12. Tape Leader and Trailer Dimensions.

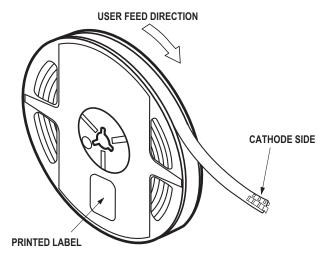


Figure 13. Reeling Orientation.

Handling Precaution

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material, please do not press on the silicone or poke a sharp object onto the silicone. These might damage the product and cause premature failure. During assembly or handling, the unit should be held on the body only. Please refer to Avago Application Note AN 5288 for detail information.

Moisture Sensitivity

This product is qualified as Moisture Sensitive Level 2 per Jedec J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling of Moisture Sensitive Surface Mount Devices for details.

A. Storage before use

- Unopen moisture barrier bag (MBB) can be stored at <40°C/90% RH for 12 months. If the actual shelf life has exceeded 12 months and the HIC indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is not recommended to open the MBB prior to assembly (e.g. for IQC).

B. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at <30°C/60% RH at all time and all high temperature related process including soldering, curing or rework need to be completed within 1 year.

C. Control for unfinished reel

 For any unused LEDs, they need to be stored in sealed MBB with desiccant or desiccator at <5% RH in order to stop the floor life. Otherwise, the floor life will continue and precaution should be taken to ensure it does not exceed 1 year.

D. Control of assembled boards

 If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5% RH to ensure no LEDs have exceeded their floor life of 1 year.

E. Baking is required if:

- "60%" HIC indicator is NOT Green.
- The LEDs are exposed to condition of >30°C/60% RH at any time.
- The LEDs floor life exceeded 1 year.

Recommended baking condition: 60±5°C for 20 hours.

Device Color (X₁)

В	Blue	
G	Green	

Intensity Bin Select (X₂X₃)

Individual reel will contain parts from one half bin only

Min I _V Bin
Full Distribution
2 half bins starting from X ₂ 1
3 half bins starting from X ₂ 1
4 half bins starting from X ₂ 1
5 half bins starting from X ₂ 1
2 half bins starting from X ₂ 2
3 half bins starting from X ₂ 2
4 half bins starting from X ₂ 2
5 half bins starting from X ₂ 2

Intensity Bin Limits

Min. (mcd)	Max. (mcd)
45.0	56.0
56.0	71.5
71.5	90.0
90.0	112.5
112.5	140.0
140.0	180.0
180.0	224.0
224.0	285.0
285.0	355.0
355.0	450.0
450.0	560.0
560.0	715.0
715.0	900.0
900.0	1125.0
	45.0 56.0 71.5 90.0 112.5 140.0 180.0 224.0 285.0 355.0 450.0 560.0 715.0

Tolerance of each bin limit = $\pm 12\%$

Color Bin Select (X₄)

Individual reel will contain parts from one sub bin only.

X ₄	
0	Full Distribution
Α	1 and 2 only
В	2 and 3 only
С	3 and 4 only
G	1, 2 and 3 only
Н	2, 3 and 4 only
Z	Special binning

Color Bin Limits

Blue	Min. (nm)	Max. (nm)	
1	460.0	465.0	
2	465.0	470.0	
3	470.0	475.0	
4	475.0	480.0	

Green	Min. (nm)	Max. (nm)
1	515.0	520.0
2	520.0	525.0
3	525.0	530.0
4	530.0	535.0

Tolerance of each bin limit = ± 1 nm

Packaging Option (X₅)

Option	Test Current	Package Type	Reel Size
2	20 mA	Top Mount	7 Inch

For product information and a complete list of distributors, please go to our web site: **www.avagotech.com**

